

10-Line to 4-Line BCD Priority Encoder

High-Voltage Types (20-Volt Rating)

The CD40147B CMOS encoder features priority encoding of the inputs to ensure that only the highest-order data line is encoded. Ten data input lines (0-9) are encoded to four-line (8, 4, 2, 1) BCD. The highest priority line is line 9. All four output lines are logic 1 (V_{SS}) when all input lines are logic 0. All inputs and outputs are buffered, and each output can drive one TTL low-power Schottky load. The CD40147B is functionally similar to the TTL54/74147 if pin 15 is tied low.

The CD40147B types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Features:

- Encodes 10-line to 4-line BCD
- Active low inputs and outputs
- Standardized, symmetrical output characteristics
- = 100% tested for quiescent current at 20 V
- = 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' ' Series CMOS Devices"
- Maximum input current of 1 µA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature

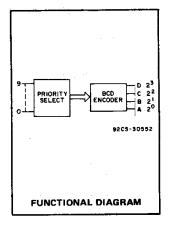
1 V at V_{DD} = 5 V 2 V at V_{DD} = 10 V

Applications:

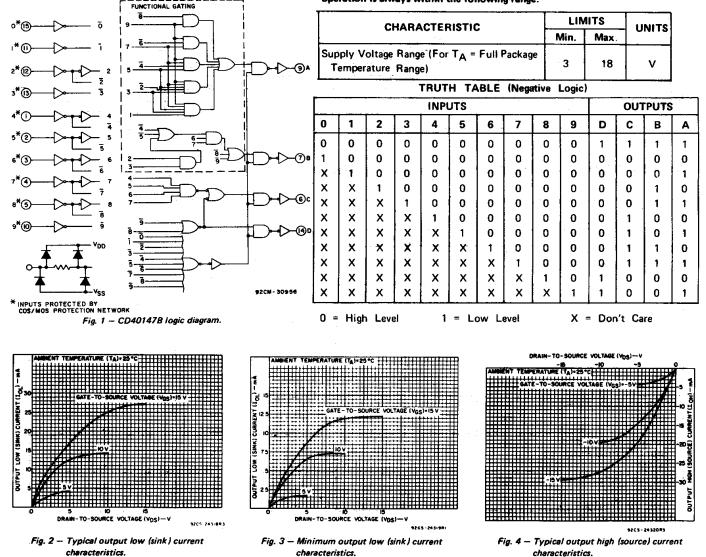
range) =

- Keyboard encoding
- = 10-line to BCD encoding
- Range selection

RECOMMENDED OPERATING CONDITIONS



For maximum reliability, nominal operating conditions should be selected so that operation is always within the following range:



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CD40147B Types

MAXIMUM RATINGS, Absolute-Maximum Values:	
DC SUPPLY-VOLTAGE RANGE, (VDD)	
Voltages referenced to V _{SS} Terminal)	
INPUT VOLTAGE RANGE, ALL INPUTS	
DC INPUT CURRENT, ANY ONE INPUT	
POWER DISSIPATION PER PACKAGE (PD):	
For $T_A = -55^{\circ}C$ to $+100^{\circ}C$	
For $T_A = +100^{\circ}C$ to $+125^{\circ}C$ Derate Linearity at $12mW/^{\circ}C$ to $200mW$	
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR T _A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	
OPERATING-TEMPERATURE RANGE (TA)	
STORAGE TEMPERATURE RANGE (Tstg)	
LEAD TEMPERATURE (DURING SOLDERING):	
At distance $1/16 \pm 1/32$ inch (1.59 ± 0.79 mm) from case for 10s max	

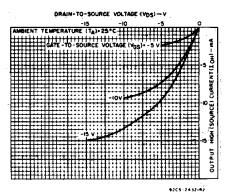
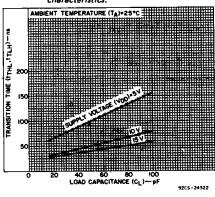


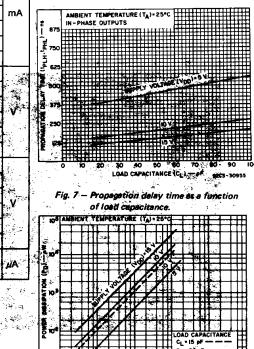
Fig. 5 — Minimum output high (source) current characteristics:



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COMMERCIAL CMOS HIGH VOLTAGE ICs

Fig. 6 – Typical transition time as a function of load capacitance.



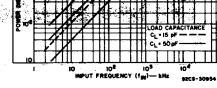


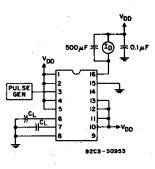
Fig. 8 - Typical dynamic power dissipation as a function of input frequency.

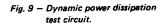
STATIC ELECTRICAL	CHARACTERISTICS

CHARAC-	CONE		IS	LI	MITS AT	INDIC/	MPER/	IPERATURES (^o C)			
TERISTIC	Vo	VIN	VDD	-55	-40	+85			+25	1	T S
Quiescent	(V) —	(∀) 0,5	(V) 5	- 33	-40	150	+125	Min.	Typ. 0.04	Max. 5	\vdash
Device		0,5	10	10	10	300	300		0.04	10	-
Current, Ipp		0,10	15	20	20	600	600		0.04	20	μA
Max.		0.20	20	100	100	3000	3000		0.04	100	
Output Low	. 0.4	0,20	5	0.64	0.61	0.42	0.36	0.51	. 1	100	
(Sink)	0.5	0,10	10	1.6	1.5	1.1	0.30	1.3	2.6	<u>↓ </u>	
Current	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	<u> </u>	
Output	4.6	0.5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1		mA
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2		````
Current,	9.5	0,10	10	-1.6	-1.5	-1,1	-0.9	-1.3	-2.6	h	
loн Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	1	
Output Voltage:		0,5	5		0.0		L	_	0	0.05	
Low-Level,	· _ ·	0,10	10		0.05				0	0.05	
Vo⊾ Max.		0,15	15		0.05				0	0.05	
Output Voltage:	·	0,5	5		4.95			4.95	5	-	N.
High-Level,		0,10	10		9.95			9.95	10	<u> </u> _ ,	143 49
Voн Min.		0,15	15		14.95			14.95	15	<u> </u>	
Input Low	0.5,4.5	<u> </u>	5		1.5			-	_	1.5	
Voltage,	1,9	—	10		3			_		3	
ViL Max.	1.5,13.5	—	15		4			_		4	
Input High	0.5,4.5	-	5		3.5			3.5	_	-	Y
Voltage,	` †,9 ́		10	7			7	1			
Vin Min.	1.5,13.5	-	15	11			11				
Input Current In Max.		0,18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁶	±0.1	щA

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25°C, Input t_r, t_f = 20 ns, C_L = 50 pF, R_L = 200 k Ω

CHARACTERISTIC	TEST CONDITIONS		LIMITS ALL TYPES		UNITS
		V _{DD} (V)	Тур.	Max.	
Propagation Delay Time,		5	450	900	
^t PLH ^{, t} PHL In-Phase Output		10	200	400	ns
	Any input to any output	15	150	300	
• • • • • • • • • • • • • • • • • • • •		5	425	850	ns
Out-of-Phase Output		10	175	350	
	·	15	125	250	
Transition Time, tTHL, tTLH		5	100	200	
		10	50	100	ns
		15	40	-80	
Input Capacitance, C ₁	Any Input		5	7.5	pF





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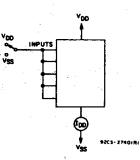


Fig. 10 — Quiescent device current test circuit.

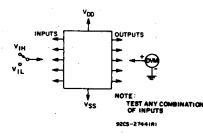
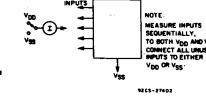
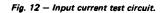
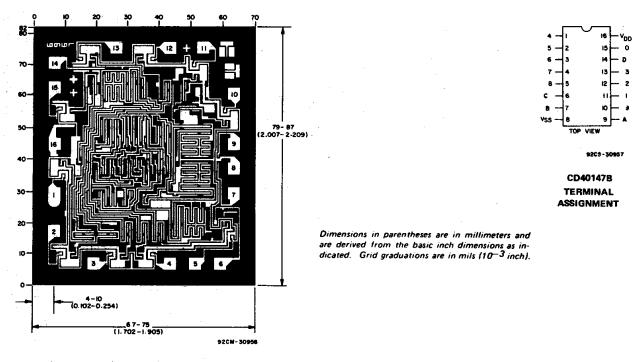


Fig. 11 - Input voltage test circuit.







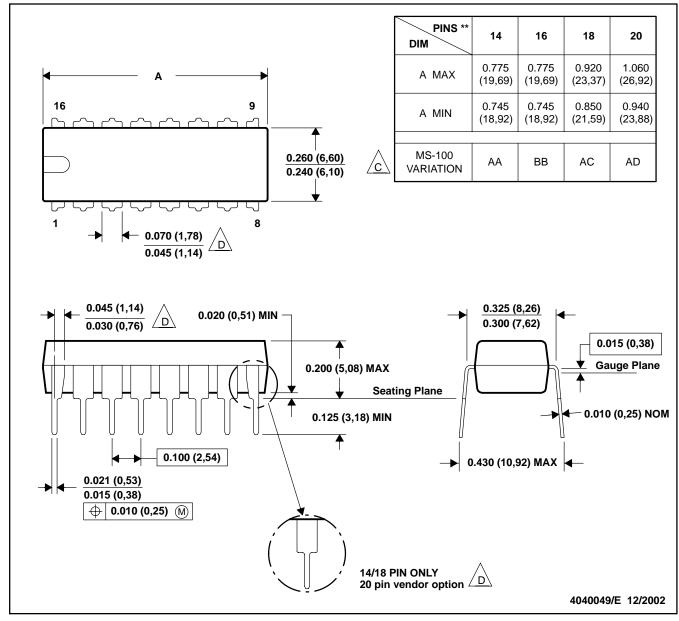


MPDI002C - JANUARY 1995 - REVISED DECEMBER 20002

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

/д.

B. This drawing is subject to change without notice.

/C Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

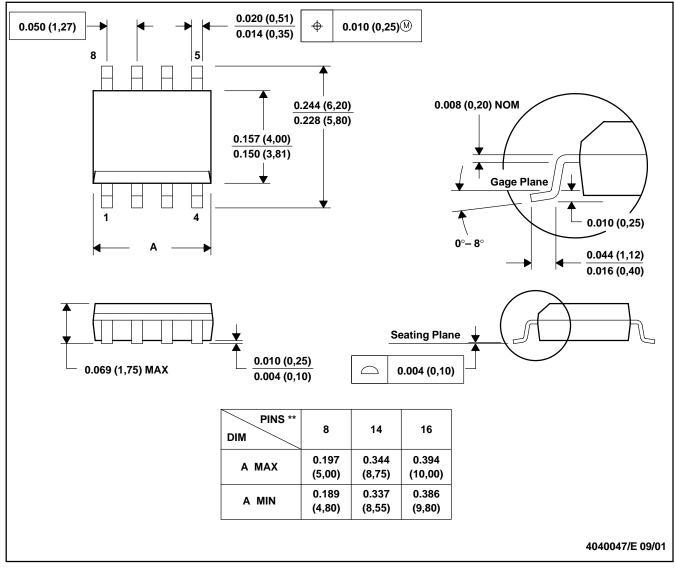


MECHANICAL DATA

MSOI002B - JANUARY 1995 - REVISED SEPTEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

D (R-PDSO-G**) 8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



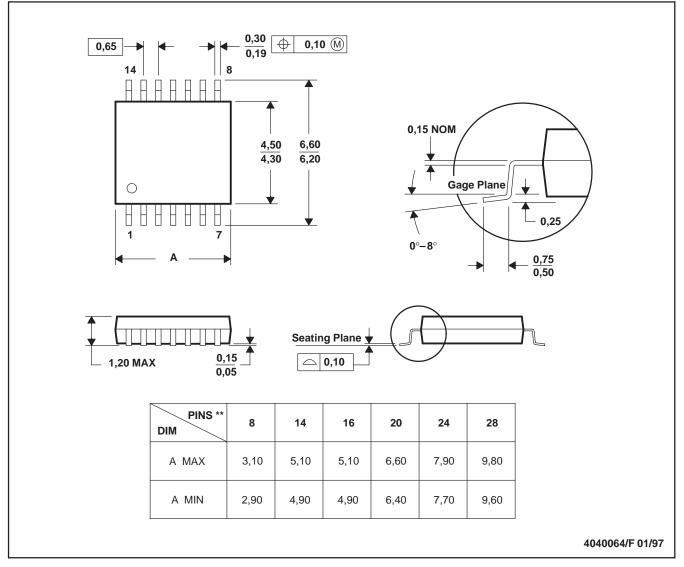
MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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